

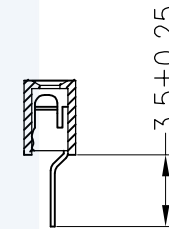
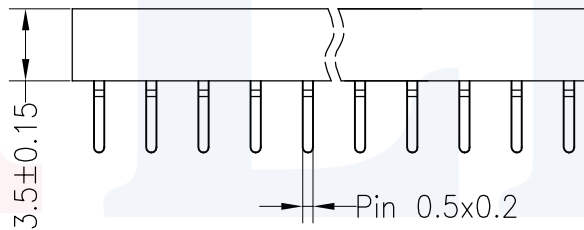
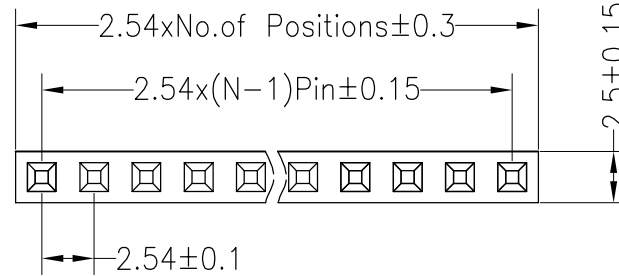
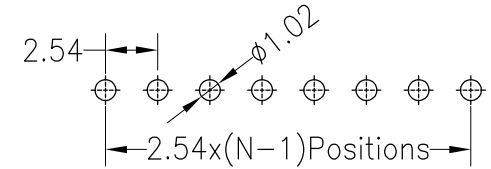


**SPECIFICATIONS**

Rated Current:3.0AMP  
 Contact Resistance:20mΩ Max  
 Withstand Voltage:1000V AC/DC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°C to +105°C

Contact Material:Brass  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:Polyester(UL94V-0)  
 Standard: PA6T  
 Max.Processing Temp: 230°C for 30-60 seconds  
 (260°C for 10 seconds)

Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



**Ordering Information**

2235 -01 XX X N XX S U X 01

No.of Pins Per Row 1\*40

Insulator Material Option  
 A=BK-PBT  
 B=BK-PA66  
 C=BK-PA6T  
 D=BK-PA46  
 F=BK-LCP

Contact Plating  
 G1:1U" Gold  
 G2:1.5U" Gold  
 G3:2U" Gold  
 G4:3U" Gold  
 G5:5U" Gold  
 G6:10U" Gold  
 G7:15U" Gold  
 S0:Gold Flash/Tin  
 SN:Tin

Packing  
 O=PE Bag  
 A=Tray  
 T=Tube  
 P=Tube+Cap  
 R=Reel+Cap  
 M=Reel+Mylar

OPERATION		DRAW	YiYuSheng	12.03.28	SCALE	FIT	<b>JILN</b> 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONIC CO.,LTD Tel: 86-755-2997-5806/5802 Fax: 86-755-2997-5992	
X.X	±0.30				UNIT	mm		
X.XX	±0.20	CHECK			SIZE	A4	PART NO.	223501XXXNXXSUX01
X.XXX	±0.10				SHEET	1/1	TITLE:	2.54PF H3.5mm 1xNpin 180° DIP
Angle	±3°	APPROVE			PROJ.	◆		
DIM	TOL							

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.03.28	NEW DRAWING	

